Chip Beads

For power line

MPZ series

Type:	**MPZ0603**	**[0201 inch]***
	MPZ1005	**[0402 inch]**
	MPZ1608	**[0603 inch]**
	MPZ2012	**[0805 inch]**

*** Dimensions Code [EIA]**

Issue date: September 2011

- All specifications are subject to change without notice.
- Conformity to RoHS Directive: This means that, in conformity with EU Directive 2002/95/EC, lead, cadmium, mercury, hexavalent chromium, and specific bromine-based flame retardants, PBB and PBDE, have not been used, except for exempted applications.

TDK

Chip Beads
For Power Line

Conformity to RoHS Directive

MPZ Series MPZ0603

FEATURES

- This chip bead implements a 0603 shape in its capacity as an EMC countermeasure component, and it supports compact devices that need smaller spaces.
- This product can cope with a high current due to its low DC resistance. It is also most suitable for lower power consumption.
- Because of its low DC resistance, it is useful for audio lines.
- No cross talk with closed magnetic circuit structural design.
- It is a product conforming to RoHS directive.

APPLICATIONS

Removal of power line noises of cellular phones, PCs, note PCs, TV tuners, STBs, audio players, DVDs, DSCs, DVCs, game machines, digital photo frames, etc.

PRODUCT IDENTIFICATION

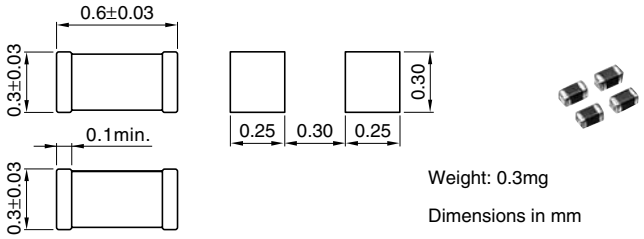
MPZ	0603	S	220	C	T
(1)	(2)	(3)	(4)	(5)	(6)

(1) Series name
(2) Dimensions L×W
(3) Material code
(4) Nominal impedance [at 100MHz]
(5) Characteristic type
(6) Packaging style
T:Taping(reel)

HANDLING AND PRECAUTIONS

- Before soldering, be sure to preheat components. The preheating temperature should be set so that the temperature difference between the solder temperature and product temperature does not exceed 150°C.
- After mounting components onto the printed circuit board, do not apply stress through board bending or mishandling.
- Do not expose the inductors to stray magnetic fields.
- Avoid static electricity discharge during handling.
- When hand soldering, apply the soldering iron to the printed circuit board only. Temperature of the iron tip should not exceed 350°C. Soldering time should not exceed 3 seconds.

SHAPES AND DIMENSIONS/RECOMMENDED PC BOARD PATTERN



Weight: 0.3mg

Dimensions in mm

TEMPERATURE RANGES

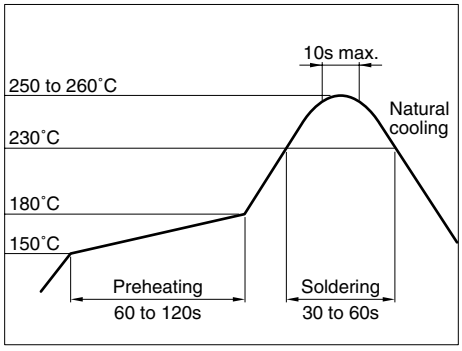
Operating/storage	–55 to +125°C

PACKAGING STYLE AND QUANTITIES

Packaging style	Quantity
Taping	15000 pieces/reel

RECOMMENDED SOLDERING CONDITION

REFLOW SOLDERING



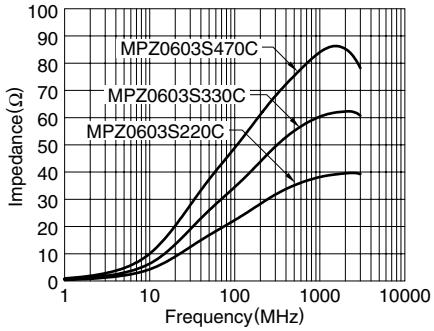
ELECTRICAL CHARACTERISTICS

Part No.	Impedance (Ω)[100MHz]*	DC resistance (Ω)max.	Rated current (mA)max.
MPZ0603S220C	22±25%	0.065	1000
MPZ0603S330C	33±25%	0.090	750
MPZ0603S470C	47±25%	0.120	500

* Test equipment: E4991A or equivalent
Test tool: 16197 or equivalent
Test temperature: 25±10°C

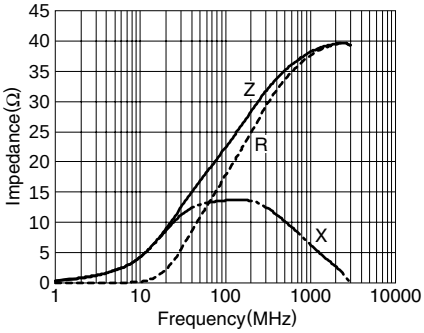
- Conformity to RoHS Directive: This means that, in conformity with EU Directive 2002/95/EC, lead, cadmium, mercury, hexavalent chromium, and specific bromine-based flame retardants, PBB and PBDE, have not been used, except for exempted applications.
- Please contact our Sales office when your application is considered the following:
The device's failure or malfunction may directly endanger human life (e.g. application for automobile/aircraft/medical/nuclear power devices, etc.)

TYPICAL ELECTRICAL CHARACTERISTICS
Z FREQUENCY CHARACTERISTICS
MPZ0603S SERIES

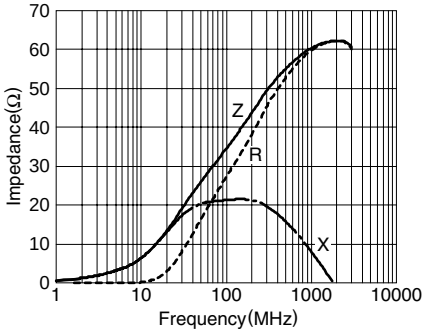


Z, X, R vs. FREQUENCY CHARACTERISTICS

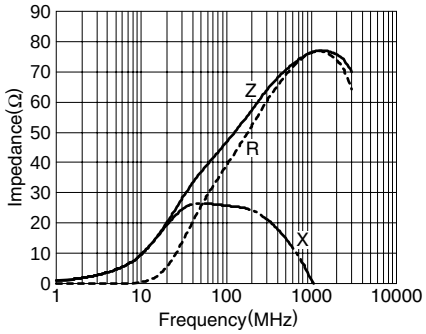
MPZ0603S220C



MPZ0603S330C

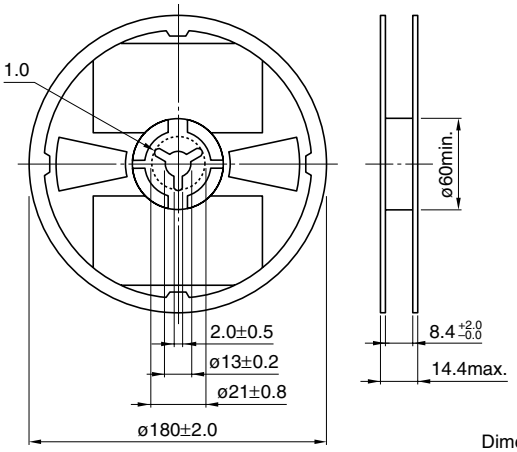


MPZ0603S470C



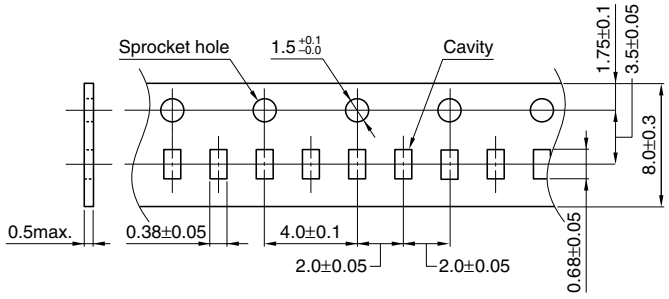
PACKAGING STYLES

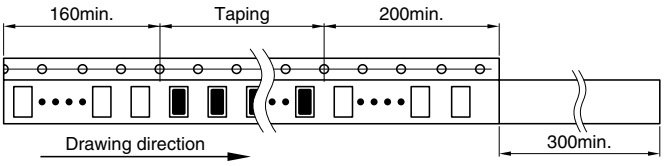
REEL DIMENSIONS



Dimensions in mm

TAPE DIMENSIONS





Dimensions in mm

Chip Beads
For Power Line

Conformity to RoHS Directive

MPZ Series MPZ1005

FEATURES
- TDK has manufactured MPZ1005 type as EMI countermeasure product for power line.
- This type is the best for energy-saving in the low DC resistance.
- No cross talk with closed magnetic circuit structural design.
- It is a product conforming to RoHS directive.

APPLICATIONS
Removal of power line noises of cellular phones, PCs, note PCs, TVs, TV tuners, STBs, audio players, DVDs, DSCs, DVCs, game machines, digital photo frames, car navigation system, PNDs, etc.

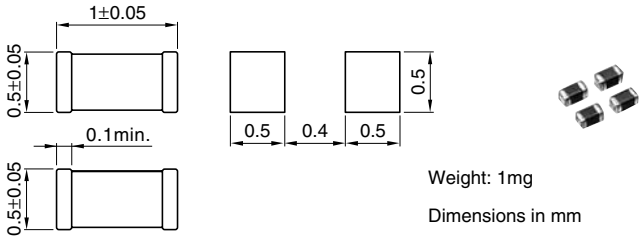
PRODUCT IDENTIFICATION

MPZ	1005	S	121	C	T
(1)	(2)	(3)	(4)	(5)	(6)

(1) Series name
(2) Dimensions L×W
(3) Material code
(4) Nominal impedance [at 100MHz]
(5) Characteristic type
(6) Packaging style
T:Taping(reel)

HANDLING AND PRECAUTIONS
- Before soldering, be sure to preheat components. The preheating temperature should be set so that the temperature difference between the solder temperature and product temperature does not exceed 150°C.
- After mounting components onto the printed circuit board, do not apply stress through board bending or mishandling.
- Do not expose the inductors to stray magnetic fields.
- Avoid static electricity discharge during handling.
- When hand soldering, apply the soldering iron to the printed circuit board only. Temperature of the iron tip should not exceed 350°C. Soldering time should not exceed 3 seconds.

SHAPES AND DIMENSIONS/RECOMMENDED PC BOARD PATTERN



Weight: 1mg

Dimensions in mm

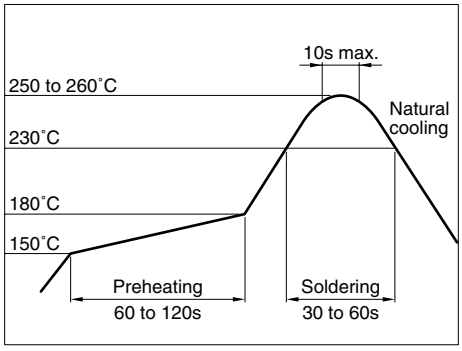
TEMPERATURE RANGES

Operating/storage	–40 to +85°C

PACKAGING STYLE AND QUANTITIES

Packaging style	Quantity
Taping	10000 pieces/reel

RECOMMENDED SOLDERING CONDITION
REFLOW SOLDERING



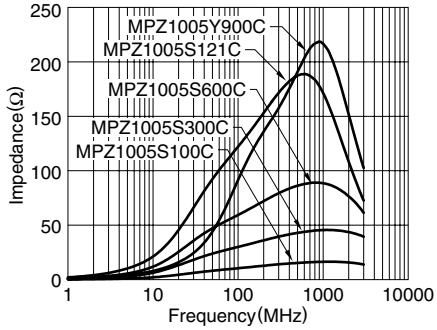
ELECTRICAL CHARACTERISTICS

Part No.	Impedance (Ω)[100MHz]*	DC resistance (Ω)max.	Rated current (A)max.
MPZ1005S100C	10±5Ω	0.045	2.0
MPZ1005S300C	30±10Ω	0.050	1.7
MPZ1005S600C	60±25%	0.075	1.5
MPZ1005S121C	120±25%	0.090	1.2
MPZ1005Y900C	90±25%	0.100	1.2

* Test equipment: E4991A or equivalent
Test tool: 16192A or equivalent
Test temperature: 25±10°C

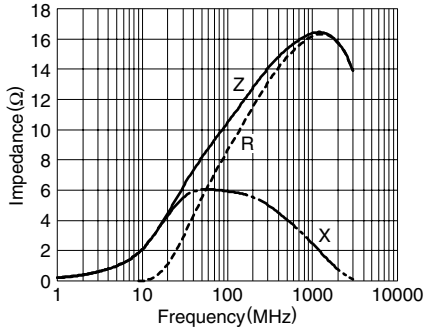
- Conformity to RoHS Directive: This means that, in conformity with EU Directive 2002/95/EC, lead, cadmium, mercury, hexavalent chromium, and specific bromine-based flame retardants, PBB and PBDE, have not been used, except for exempted applications.
- Please contact our Sales office when your application is considered the following:
The device's failure or malfunction may directly endanger human life (e.g. application for automobile/aircraft/medical/nuclear power devices, etc.)

TYPICAL ELECTRICAL CHARACTERISTICS
Z FREQUENCY CHARACTERISTICS
MPZ1005S/MPZ1005Y SERIES

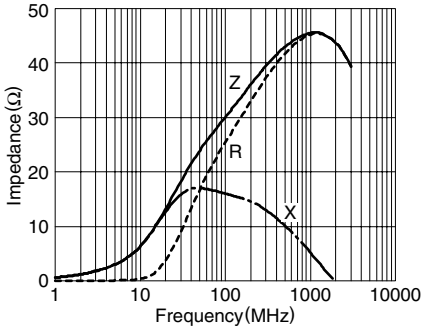


Z, X, R vs. FREQUENCY CHARACTERISTICS

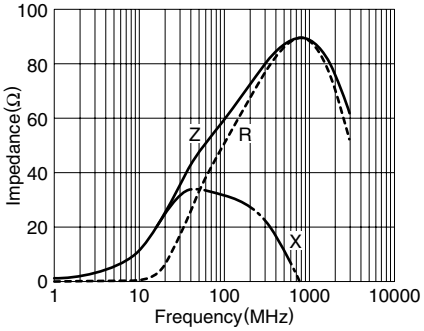
MPZ1005S100C



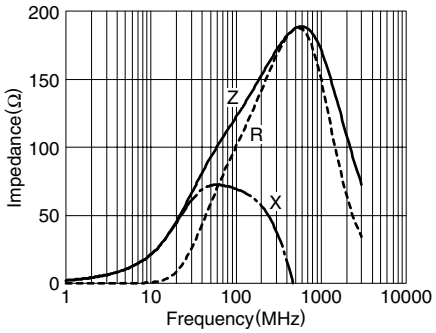
MPZ1005S300C



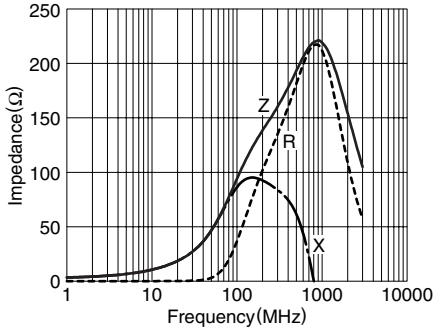
MPZ1005S600C



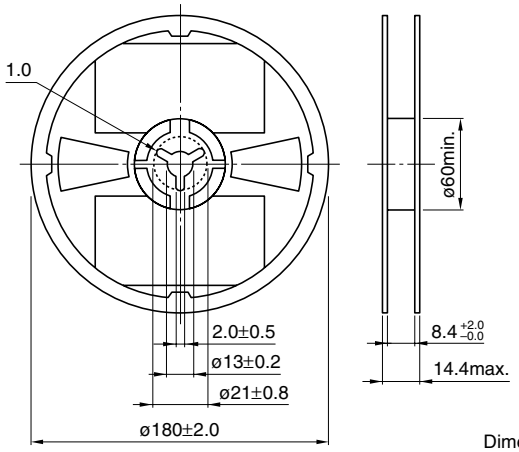
MPZ1005S121C



MPZ1005Y900C

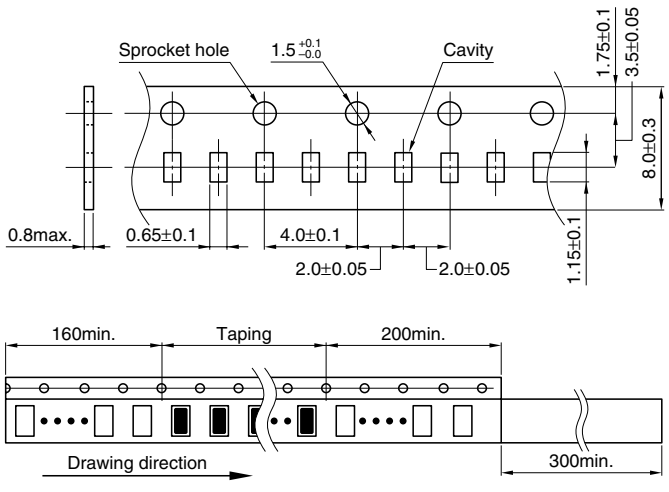


PACKAGING STYLES
REEL DIMENSIONS



Dimensions in mm

TAPE DIMENSIONS



Dimensions in mm

Chip Beads
For Power Line

Conformity to RoHS Directive

MPZ Series MPZ1608

FEATURES

- This type is the best for energy-saving in the low DC resistance.
- The products contain no lead and also support lead-free soldering.
- It is a product conforming to RoHS directive.

APPLICATIONS

Removal of power line noises of cellular phones, PCs, note PCs, TVs, TV tuners, STBs, audio players, DVDs, DSCs, DVCs, game machines, digital photo frames, car navigation system, PNDs, etc.

PRODUCT IDENTIFICATION

MPZ	1608	S	221	A	T
(1)	(2)	(3)	(4)	(5)	(6)

(1) Series name
(2) Dimensions L×W
(3) Material code
(4) Nominal impedance
221: 220Ω at 100MHz
(5) Characteristic type
(6) Packaging style
T: Taping

HANDLING AND PRECAUTIONS

- Before soldering, be sure to preheat components. The preheating temperature should be set so that the temperature difference between the solder temperature and product temperature does not exceed 150°C.
- After mounting components onto the printed circuit board, do not apply stress through board bending or mishandling.
- Do not expose the inductors to stray magnetic fields.
- Avoid static electricity discharge during handling.
- When hand soldering, apply the soldering iron to the printed circuit board only. Temperature of the iron tip should not exceed 350°C. Soldering time should not exceed 3 seconds.

MATERIAL CHARACTERISTICS

B material: This type is perfectly suited for fast digital signals. By equalizing R components and X components that beads possess at a frequency of 5MHz, it is able to suppress overshooting, undershooting and ringing of fast digital signals.

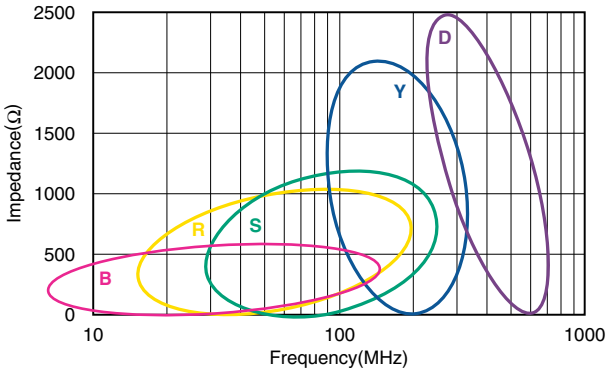
R material: For wide frequency applications calling for broad impedance characteristics.
For digital signal line applications calling requiring good waveform integrity. Impedance values selected for effectiveness at 10 to 200MHz.

S material: Standard type that features impedance characteristics similar to those of a typical ferrite core.
For signal line applications in which the blocking region is near 100MHz. Impedance values selected for effectiveness at 40 to 300MHz.

Y material: High frequency range type intended for the 100MHz region and above.
For signal line applications in which the signal frequency is far from the cutoff frequency. Impedance values selected for effectiveness at 80 to 400MHz.

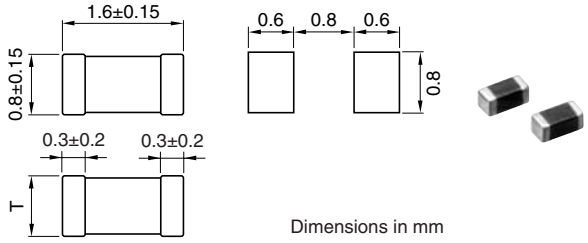
D material: For applications calling for low insertion loss at low frequencies and sharply increasing impedance at high frequencies. Designed for high impedance at high frequencies (300MHz to 1GHz) for signal line applications.

TYPICAL MATERIAL CHARACTERISTICS



- Conformity to RoHS Directive: This means that, in conformity with EU Directive 2002/95/EC, lead, cadmium, mercury, hexavalent chromium, and specific bromine-based flame retardants, PBB and PBDE, have not been used, except for exempted applications.
- Please contact our Sales office when your application is considered the following:
The device's failure or malfunction may directly endanger human life (e.g. application for automobile/aircraft/medical/nuclear power devices, etc.)

SHAPES AND DIMENSIONS/RECOMMENDED PC BOARD PATTERN



Dimensions in mm

Thickness(T)	Weight
0.6±0.15mm	3mg
0.8±0.15mm	4mg

TEMPERATURE RANGES

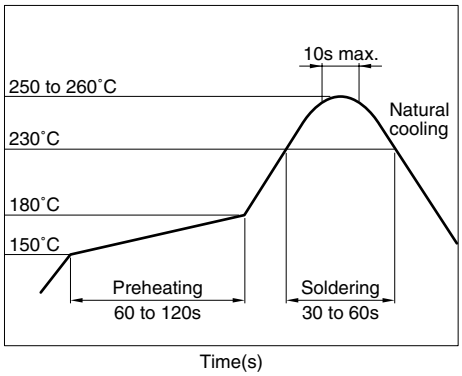
Operating/storage	–55 to +125°C

PACKAGING STYLE AND QUANTITIES

Packaging style	Quantity
Taping	4000 pieces/reel

RECOMMENDED SOLDERING CONDITION

REFLOW SOLDERING



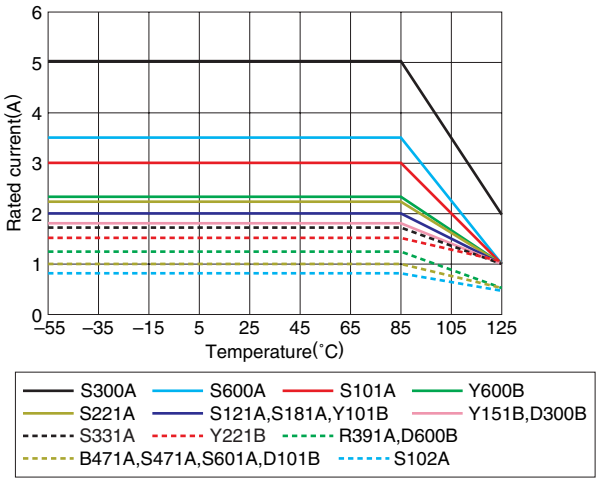
ELECTRICAL CHARACTERISTICS

Part No.	Impedance (Ω)[100MHz]*1	DC resistance (Ω)max.	Rated current*2 (A)max.	Thickness T(mm)
MPZ1608B471A	470±25%	0.150	1.0	0.8
MPZ1608S300A	30±10Ω	0.010	5.0	0.6
MPZ1608S600A	60±25%	0.020	3.5	0.6
MPZ1608S101A	100±25%	0.030	3.0	0.6
MPZ1608S121A	120±25%	0.045	2.0	0.6
MPZ1608S181A	180±25%	0.050	2.0	0.6
MPZ1608S221A	220±25%	0.050	2.2	0.8
MPZ1608S331A	330±25%	0.080	1.7	0.8
MPZ1608R391A	390±25%	0.120	1.2	0.8
MPZ1608S471A	470±25%	0.150	1.0	0.8
MPZ1608S601A	600±25%	0.150	1.0	0.8
MPZ1608S102A	1000±25%	0.300	0.8	0.8
MPZ1608Y600B	60±25%	0.030	2.3	0.8
MPZ1608Y101B	100±25%	0.040	2.0	0.8
MPZ1608Y151B	150±25%	0.050	1.8	0.8
MPZ1608Y221B	220±25%	0.100	1.5	0.8
MPZ1608D300B	30±10Ω	0.060	1.8	0.8
MPZ1608D600B	60±25%	0.100	1.2	0.8
MPZ1608D101B	100±25%	0.150	1.0	0.8

*1 Test equipment: E4991A or equivalent
Test tool: 16192A or equivalent
Test temperature: 25±10°C

*2 Please refer to the graph of RATED CURRENT vs. TEMPERATURE CHARACTERISTICS(DERATING) about the rating current at 85°C or more in temperature of the product.

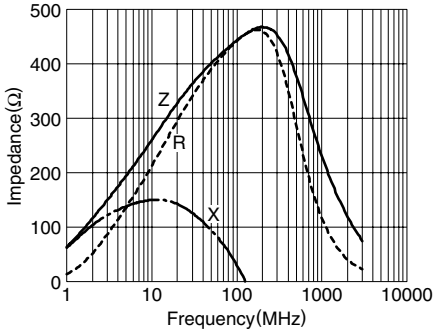
RATED CURRENT vs. TEMPERATURE CHARACTERISTICS (DERATING)



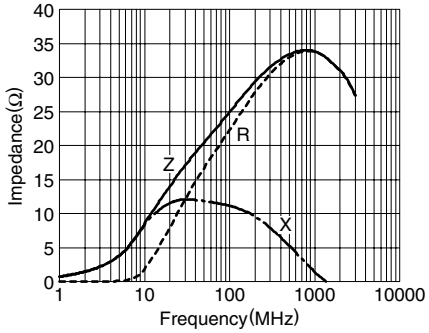
TYPICAL ELECTRICAL CHARACTERISTICS

Z, X, R vs. FREQUENCY CHARACTERISTICS

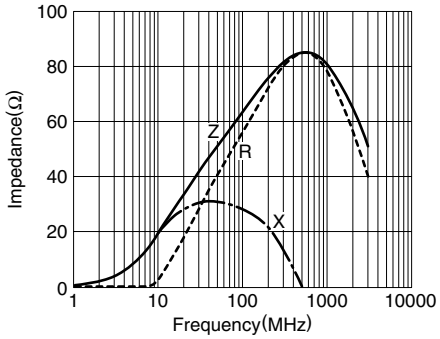
MPZ1608B471A



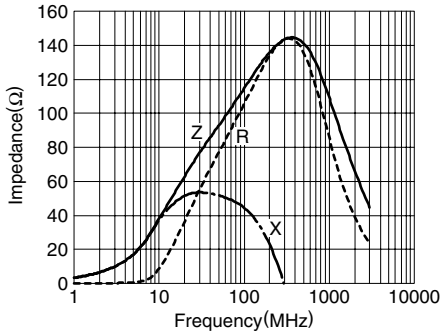
MPZ1608S300A



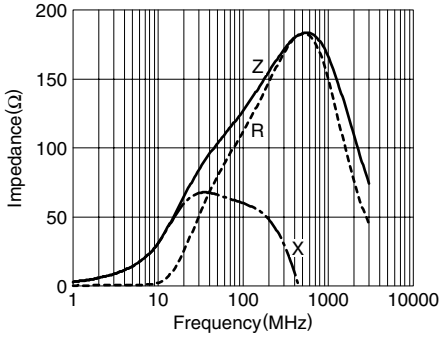
MPZ1608S600A



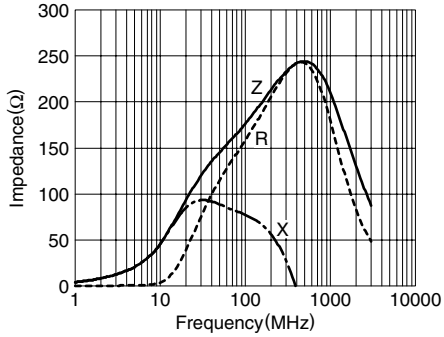
MPZ1608S101A



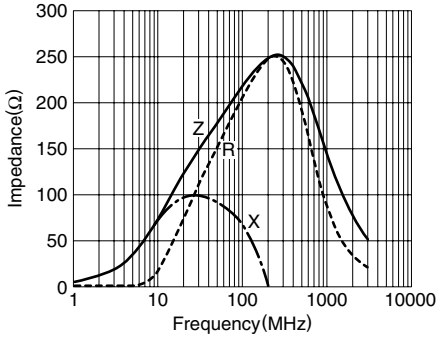
MPZ1608S121A



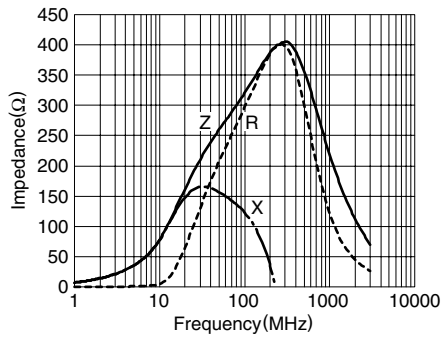
MPZ1608S181A



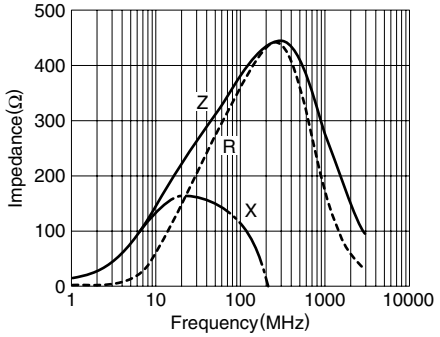
MPZ1608S221A



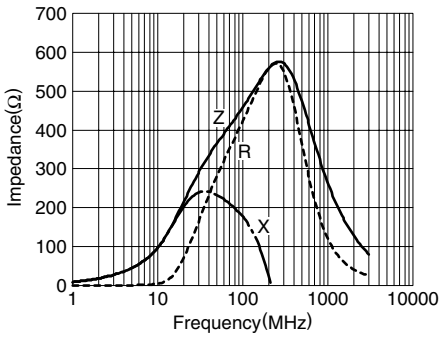
MPZ1608S331A



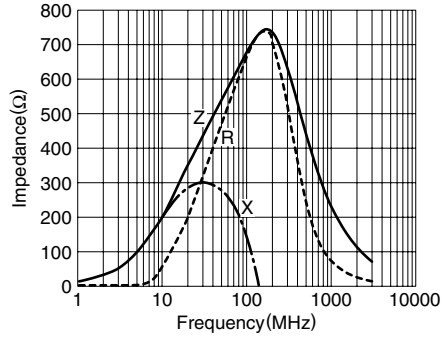
MPZ1608R391A



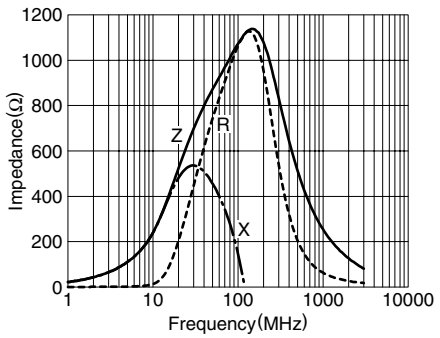
MPZ1608S471A



MPZ1608S601A



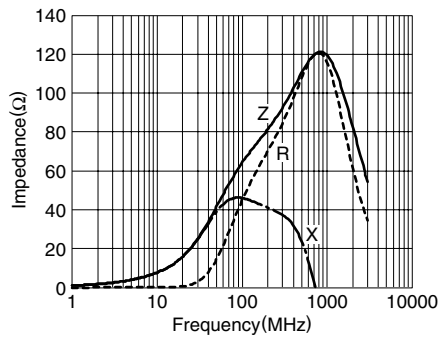
MPZ1608S102A



TYPICAL ELECTRICAL CHARACTERISTICS

Z, X, R vs. FREQUENCY CHARACTERISTICS

MPZ1608Y600B



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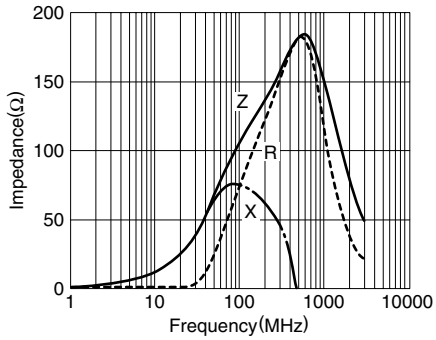

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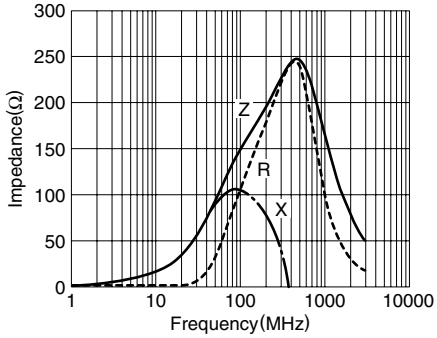

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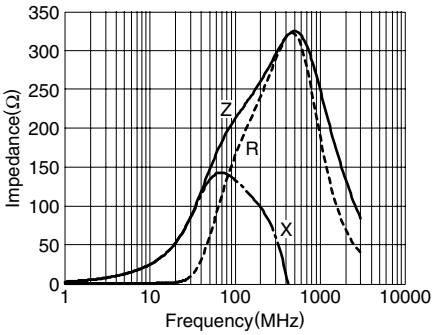
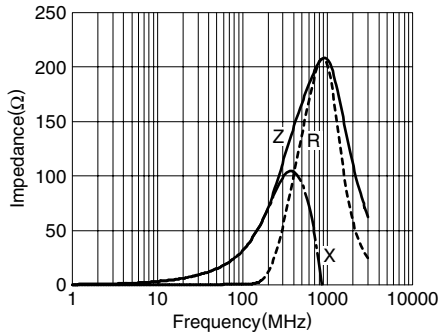


MPZ1608D300B



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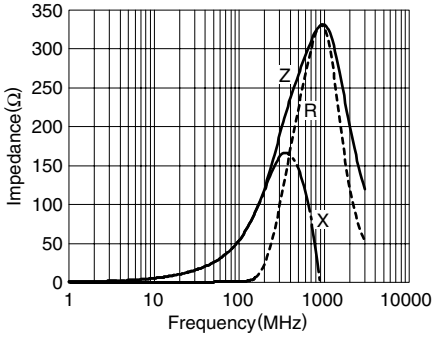

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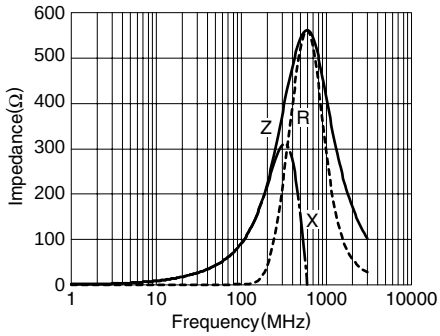
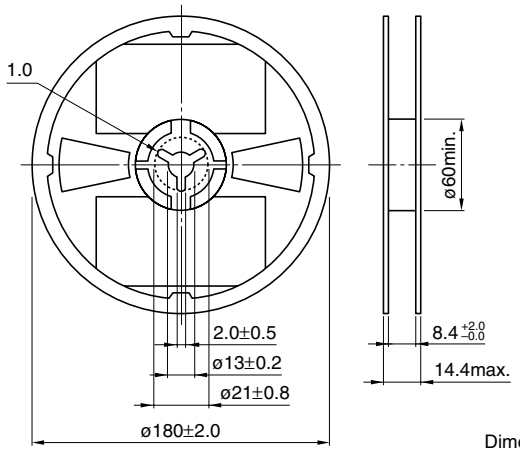


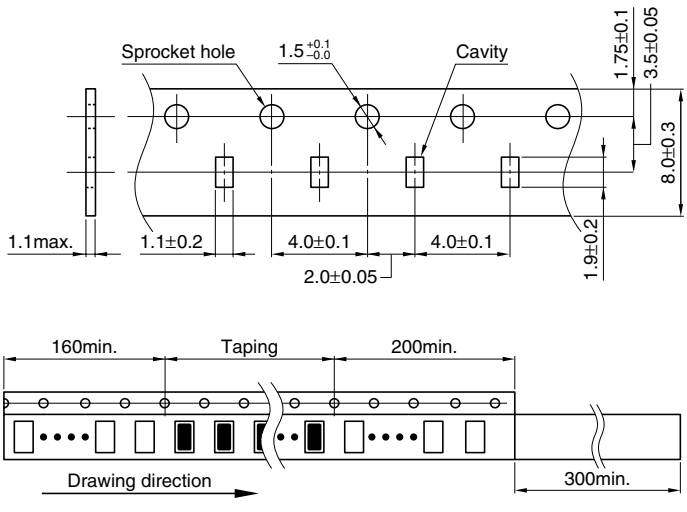
PACKAGING STYLES

REEL DIMENSIONS



Dimensions in mm

TAPE DIMENSIONS



Dimensions in mm

• All specifications are subject to change without notice.

Chip Beads
For Power Line

Conformity to RoHS Directive

MPZ Series MPZ2012

FEATURES

- The MPZ series are multilayer chip impeders for power supply line applications.
- High miniaturized, these parts nonetheless exhibit low DC resistance and high current handling capability.
- The products contain no lead and also support lead-free soldering.
- It is a product conforming to RoHS directive.

APPLICATIONS

Removal of power line noises of cellular phones, PCs, note PCs, TVs, TV tuners, STBs, audio players, DVDs, DSCs, DVCs, game machines, digital photo frames, car navigation system, PNDs, etc.

PRODUCT IDENTIFICATION

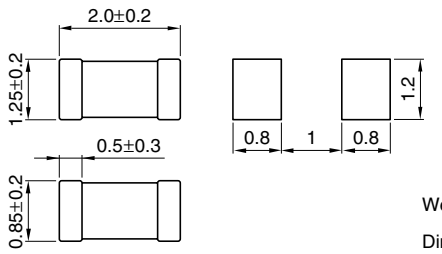
MPZ	2012	S	331	A	T
(1)	(2)	(3)	(4)	(5)	(6)

(1)Series name
(2)Dimensions L×W
(3)Material code
(4)Nominal impedance
331: 330Ω at 100MHz
(5)Characteristic type
(6)Packaging style
T: Taping

HANDLING AND PRECAUTIONS

- Before soldering, be sure to preheat components. The preheating temperature should be set so that the temperature difference between the solder temperature and product temperature does not exceed 150°C.
- After mounting components onto the printed circuit board, do not apply stress through board bending or mishandling.
- Do not expose the inductors to stray magnetic fields.
- Avoid static electricity discharge during handling.
- When hand soldering, apply the soldering iron to the printed circuit board only. Temperature of the iron tip should not exceed 350°C. Soldering time should not exceed 3 seconds.

SHAPES AND DIMENSIONS/RECOMMENDED PC BOARD PATTERN



Weight: 8mg

Dimensions in mm

TEMPERATURE RANGES

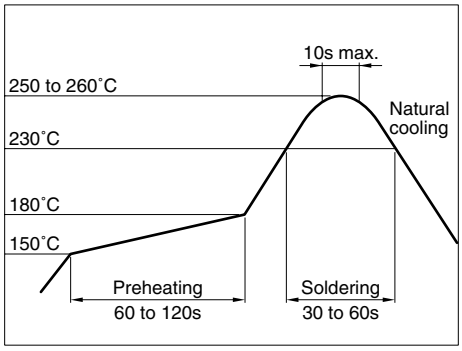
Operating/storage	–55 to +125°C

PACKAGING STYLE AND QUANTITIES

Packaging style	Quantity
Taping	4000 pieces/reel

RECOMMENDED SOLDERING CONDITION

REFLOW SOLDERING



- Conformity to RoHS Directive: This means that, in conformity with EU Directive 2002/95/EC, lead, cadmium, mercury, hexavalent chromium, and specific bromine-based flame retardants, PBB and PBDE, have not been used, except for exempted applications.
- Please contact our Sales office when your application is considered the following:
The device's failure or malfunction may directly endanger human life (e.g. application for automobile/aircraft/medical/nuclear power devices, etc.)

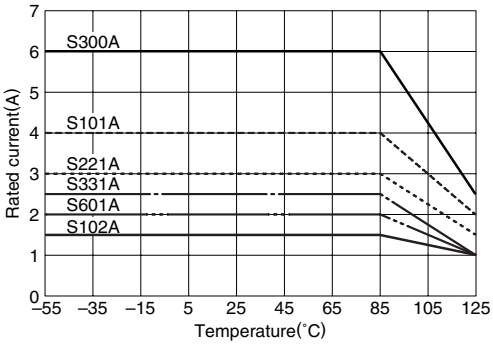
ELECTRICAL CHARACTERISTICS

Part No.	Impedance (Ω)[100MHz]*1	DC resistance (Ω)max.	Rated current*2 (A)max.
MPZ2012S300A	30±10Ω	0.010	6
MPZ2012S101A	100±25%	0.020	4
MPZ2012S221A	220±25%	0.040	3
MPZ2012S331A	330±25%	0.050	2.5
MPZ2012S601A	600±25%	0.100	2
MPZ2012S102A	1000±25%	0.150	1.5

*1 Test equipment: E4991A or equivalent
Test tool: 16192A or equivalent
Test temperature: 25±10°C

*2 Please refer to the graph of RATED CURRENT vs. TEMPERATURE CHARACTERISTICS(DERATING) about the rating current at 85°C or more in temperature of the product.

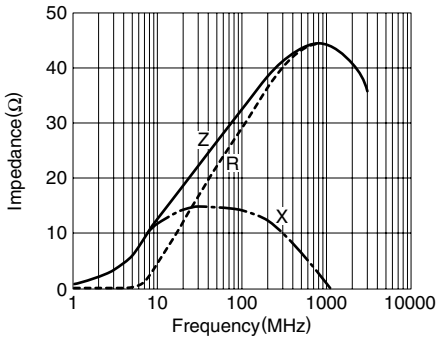
RATED CURRENT vs. TEMPERATURE CHARACTERISTICS (DERATING)



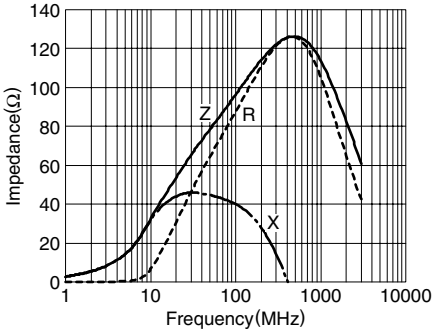
TYPICAL ELECTRICAL CHARACTERISTICS

Z, X, R vs. FREQUENCY CHARACTERISTICS

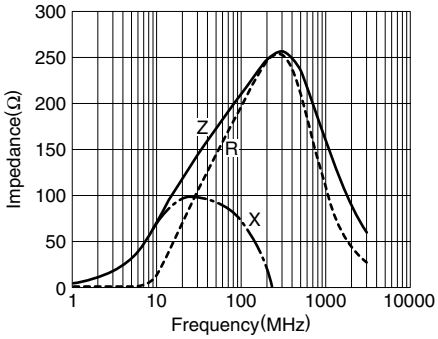
MPZ2012S300A



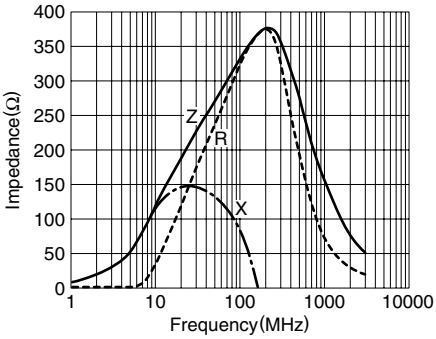
MPZ2012S101A



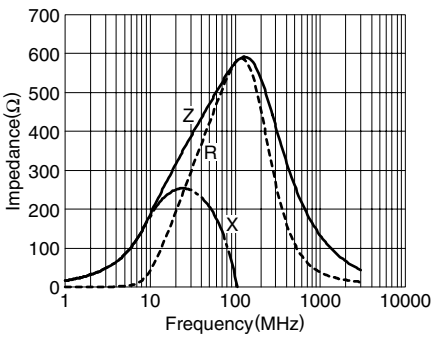
MPZ2012S221A



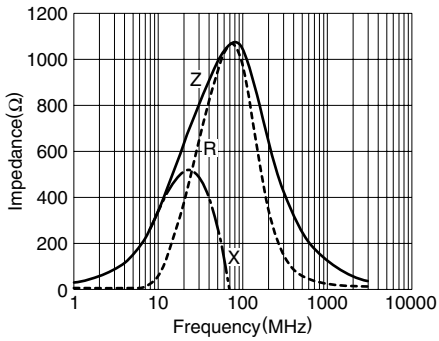
MPZ2012S331A



MPZ2012S601A

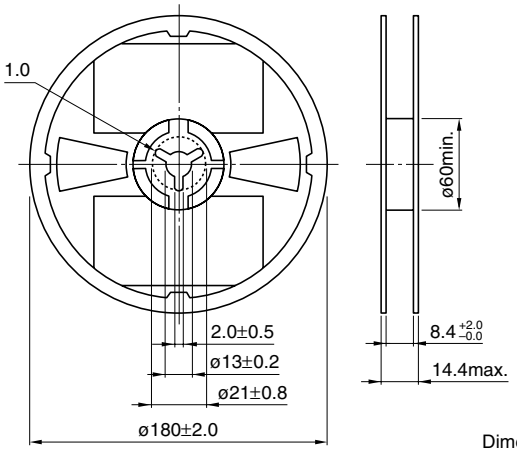


MPZ2012S102A



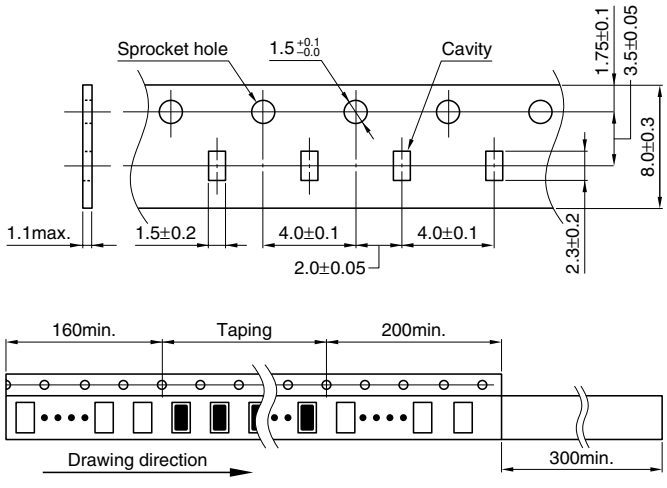
PACKAGING STYLES

REEL DIMENSIONS



Dimensions in mm

TAPE DIMENSIONS



Dimensions in mm